



IN RE APPLICATION OF

Michael Yeung et al.

FOR

METHOD AND SYSTEM FOR WIRELESS INTERFACING OF ELECTRONIC DEVICES

APPLICATION NO.

10/054,513

FILING DATE

November 13, 2001

EXAMINER

Unknown

ART UNIT

2681

DOCKET NO.

66329/20690

ADDED PAGE TO DECLARATION AND POWER OF ATTORNEY FOR SIGNATURE BY JOINT INVENTORS ON BEHALF OF A NON-SIGNING INVENTOR WHO CANNOT BE REACHED (37 C.F.R. § 1.47(a))

BOX MISSING PARTS
Assistant Commissioner for Patents
Washington, D.C. 20231

RECEIVED

SEP 2 0 2002

Dear Sir:

OFFICE OF PETITIONS

I am an above named joint inventor and have signed this declaration on my own behalf and also sign this declaration under 37 C.F.R. 1.47(a) on behalf of the non-signing joint inventor, BRAD EMERSON, who cannot be found or reached. The last known address for Brad Emerson, a citizen of the United States, is 1765 Santa Anna Avenue, Apartment V-103, Costa Mesa, California 92627.

Accompanying this declaration is a Statement of Facts in Support of Filing on Behalf of Non-signing Inventor and the petition fee of \$130.00 under 37 C.F.R. § 1.17(i).

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Date

By: MICHAEL YEUNG

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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8/20/2002

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8/20/2002

Date

By: LOUIS ORMOND

CLE 673928.1 66329/20690



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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STATEMENT OF FACTS IN SUPPORT OF FILING ON BEHALF OF NON-SIGNING INVENTOR (37 C.F.R. § 1.47)

BOX MISSING PARTS
Assistant Commissioner for Patents
Washington, D.C. 20231

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SEP 2 0 2002

Dear Sir:

OFFICE OF PETITIONS

This statement is made as to the exact facts that are relied upon to establish the diligent effort made to secure the execution of the declaration, assignment and power of attorney by the non-signing inventor for the above-identified patent application before and after deposit thereof in the Patent and Trademark Office.

This statement is being made by the available person having first-hand knowledge of the facts recited therein:

I, Michael Yeung, hereby declare:

1. I am a co-inventor and the Director of Engineering, Document Solutions
Engineering, for Toshiba American Business Solutions, Inc., and am responsible for

overseeing all patents and patent applications related to Document Solutions Engineering, including Application No. 10/054,513, and as such have personal knowledge of the facts contained in this declaration.

- 2. Prior to filing the application and pursuant to receiving a Notice to File Missing Parts of Non-Provisional Application mailed February 21, 2002, I have been attempting to contact Brad Emerson, one of inventors of this application so he can sign the declaration, power of attorney and assignment. I have also instructed our attorneys filing this application to attempt to contact Mr. Emerson. However, numerous attempts to contact him at his last known address, 1765 Santa Anna Avenue, Apt. V-103, Costa Mesa, California 92627, and phone number, (949) 548-7814, have been unsuccessful.
- 3. More specifically, we have repeatedly attempted to contact him by telephone and by Certified Mail, as shown in the attached letter. When telephoning Mr. Emerson, we are told that the line has been disconnected. Further, we have received no response to our letters. We have also unsuccessfully attempted to find possible new addresses for Mr. Emerson through various internet address directories.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

8/19/02

By: MICHAEL YEUNG

CLE 674283.1 66329/20690



Cleveland

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Dayton

Irvine



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Direct Dial: (216) 696-3466 Internet Address: susan.mizer@arterhadden.com

July 25, 2002

CERTIFIED MAIL RETURN RECEIPT REQUESTED

Mr. Brad Emerson 1765 Santa Anna Avenue Apartment V-103 Costa Mesa, California 92627

Re:

Toshiba Patent Application Entitled:

"A Method and System for Wireless Interfacing of Electronic Devices" having

Serial No: 10/054,513 Filed: November 13, 2001

Dear Mr. Emerson:

We represent Toshiba American Business Solutions before the U.S. Patent & Trademark Office for the above-referenced patent application. It is our understanding that while employed by Toshiba you were involved in the development of the above-referenced invention, and were subsequently named as inventor on the invention disclosure form provided to us by Toshiba.

Patent Office procedures require us to submit a Declaration signed by all inventors, which affirms that the named inventors were the original and first inventors of the subject matter claimed and for which a patent is sought. Enclosed please find such a Declaration for your signature. Also enclosed is an Assignment, which transfers all right, title and interest in and to said application from the inventors to Toshiba, as the invention was made in a work-made-for-hire capacity.

Please sign both the Declaration/Power of Attorney and Assignment at the indicated areas and return them to us at your earliest convenience for filing with the Patent Office. Naturally, please contact us if you have any questions or concerns.

Sincerely yours,

ARTER & HADDEN LLP

. Mizer

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